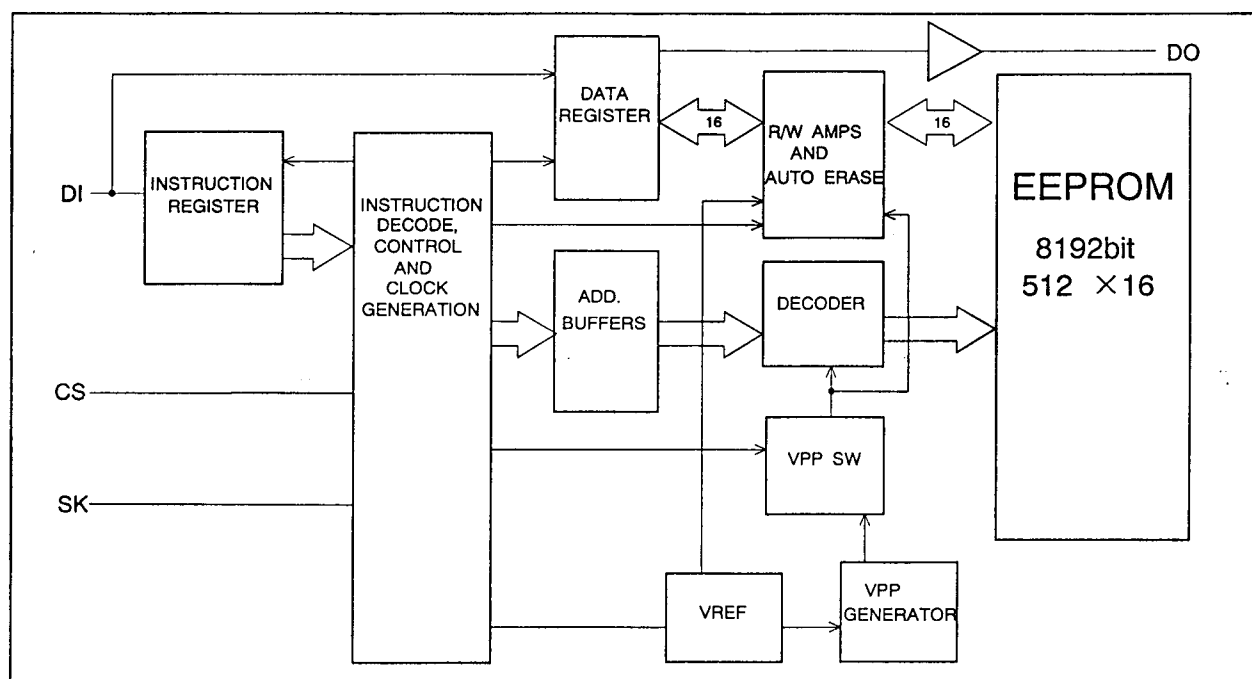


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**AK93C75A****8192bit Serial CMOS EEPROM****Features**

- ☐ ADVANCED CMOS E² PROM TECHNOLOGY
- ☐ READ/WRITE NON- VOLATILE MEMORY
- ☐ WIDE VCC OPERATION ... V_{CC} = 1.8V ~ 5.5V
- ☐ 8192 bits, 512 × 16 organization
- ☐ SERIAL INTERFACE
 - Interfaces with popular microcontrollers and standard microprocessors
- ☐ LOW POWER CONSUMPTION
 - 0.4mA max. Read Operation
 - 0.8 μ A max. Standby
- ☐ Automatic address increment (READ)
- ☐ Automatic write cycle time- out with auto- ERASE
- ☐ Busy/Ready status signal
- ☐ Software and Hardware controlled write protection
- ☐ IDEAL FOR LOW DENSITY DATA STORAGE
 - Low cost, space saving, 8- pin package



Block Diagram

General Description

The AK93C75A is a 8192-bit serial CMOS E²PROM divided into 512 registers of 16 bits each. The AK93C75A has 4 instructions such as READ, WRITE, EWEN and EWDS. Those instructions control the AK93C75A.

The AK93C75A can operate full function under wide operating voltage range from 1.8V to 5.5V.

The charge up circuit is integrated for high voltage generation that is used for write operation.

A serial interface of AK93C75A, consisting of chip select (CS), serial clock (SK), data-in (DI) and data-out (DO), can easily be controlled by popular microcontrollers or standard microprocessors.

AK93C75A takes in the write data from data input pin (DI) to a register synchronously with rising edge of input pulse of serial clock pin (SK). And at read operation, AK93C75A takes out the read data from a register to data output pin (DO) synchronously with rising edge of SK.

The DO pin is usually in high impedance state. The DO pin outputs "L" or "H" in case of data output or Busy/Ready signal output.

- Software controlled write protection

When Vcc is applied to the part, the part automatically powers up in the ERASE/WRITE Disable state. In the ERASE/WRITE disable state, execution of WRITE instruction is disabled. Before WRITE instruction is executed, EWEN instruction must be executed. The ERASE/WRITE enable state continues until EWDS instruction is executed or Vcc is removed from the part.

Execution of a read instruction is independent of both EWEN and EWDS instructions.

- Busy/Ready status signal

After a write instruction, the DO output serves as a Busy/Ready status indicator. After the falling edge of the CS initiates the self-timed programming cycle, the DO indicates the Busy/Ready status of the chip if the CS is brought high after a minimum of 250ns (Tcs). DO=logical "0" indicates that programming is still in progress. DO=logical "1" indicates that the register at the address specified in the instruction has been written with the new data pattern contained in the instruction and the part is ready for a next instruction.

The Busy/Ready status indicator is only valid when CS is active (high). When CS is low, the DO output goes into a high impedance state.

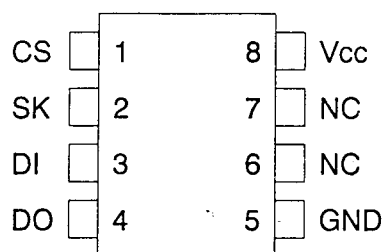
The Busy/Ready signal outputs until a start bit (Logic"1") of the next instruction is given to the part.

■ Type of Products

Model	Memory size	Temp.Range	Vcc	Package
AK93C75A	8192 bits	- 40 °C ~ 85 °C	1.8V ~ 5.5V	8pin Plastic DIP
AK93C75AF	8192 bits	- 40 °C ~ 85 °C	1.8V ~ 5.5V	8pin Plastic SOP
AK93C75ANF	8192 bits	- 40 °C ~ 85 °C	1.8V ~ 5.5V	8pin Plastic SOP
AK93C75AV	8192 bits	- 40 °C ~ 85 °C	1.8V ~ 5.5V	8pin Plastic TSSOP

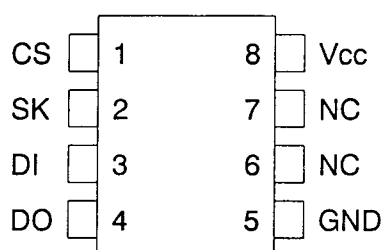
Pin arrangement

AK93C75A



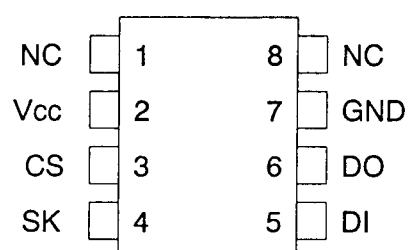
8pinDIP

AK93C75ANF



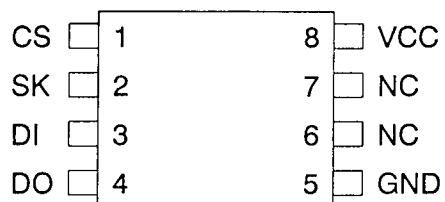
8pinSOP

AK93C75AF



8pinSOP

AK93C75AV



8pinTSSOP

Pin Name	Function
CS	Chip Select
SK	Serial Data Clock
DI	Serial Data Input
DO	Serial Data Output
GND	Ground
Vcc	Power Supply
NC	Not Connected

Functional Description

The AK93C75A has 4 instructions such as READ, WRITE, EWEN and EWDS. A valid instruction consists of a Start Bit (Logic"1"), the appropriate Op Code and the desired memory Address location.

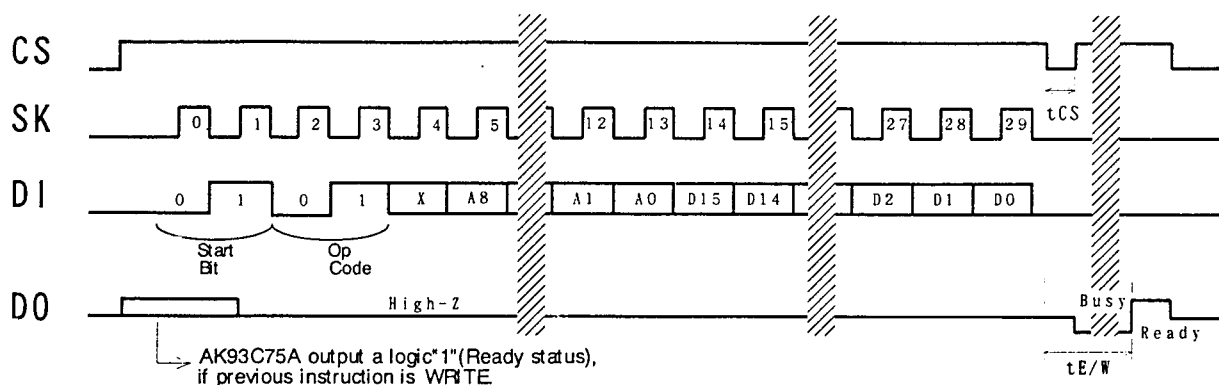
The CS pin must be brought low for a minimum of 250ns (Tcs) between each instruction when the instruction is continuously executed.

Instruction	Start Bit	Op Code	Address	Data	Comments
READ	1	10	XA8- A0	D15- D0	Reads data stored in memory, at specified address.
WRITE	1	01	XA8- A0	D15- D0	Writes register.
EWEN	1	00	11XXXXXXXX		Write enable must precede all programming modes.
EWDS	1	00	00XXXXXXXX		Disables all programming instructions.
WRAL	1	00	01XXXXXXXX	D15- D0	Writes all registers.

- (Note) • The WRAL instruction are used for factory function test only.
User can't use the WRAL instruction.
- The AK93C75A perceives the start bit in the logic"1" and also "01".

Write

The write instruction is followed by 16 bits of data to be written into the specified address. After the last bit of data is put on the DI pin, the CS pin must be brought low before the next rising edge of the SK clock. This falling edge of the CS initiates the self-timed programming cycle. The DO indicates the Busy/Ready status of the chip if the CS is brought high after a minimum of 250ns (Tcs). DO=logical "0" indicates that programming is still in progress. DO=logical "1" indicates that the register at the address specified in the instruction has been written with the new data pattern contained in the instruction and the part is ready for a next instruction.



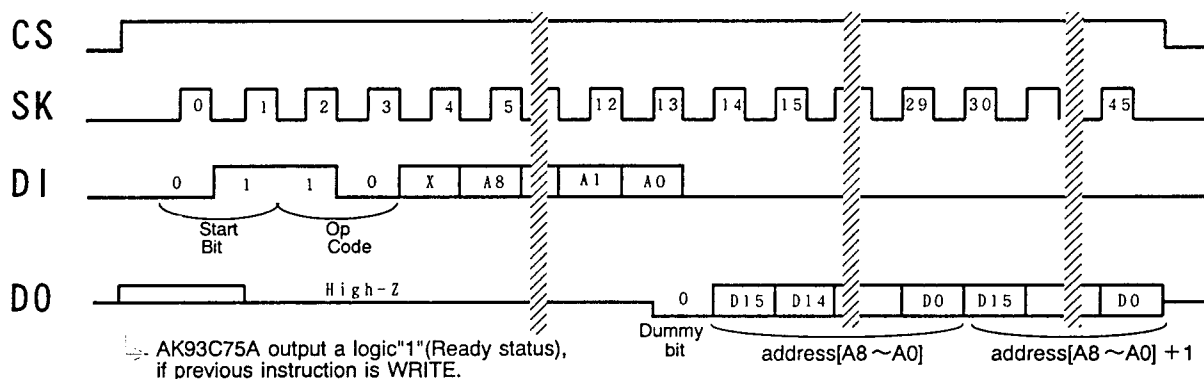
WRITE

Read

The read instruction is the only instruction which outputs serial data on the DO pin.

Following the Start bit, first Op code and address are decoded, then the data from the selected memory location is available at the DO pin. A dummy bit (logical "0") precedes the 16-bit data from the selected memory location. The output data changes are synchronized with the rising edges of the serial clock (SK).

The data in the next address can be read sequentially by continuing to provide clock. The address automatically cycles to the next higher address after the 16bit data shifted out. When the highest address is reached (\$1FF), the address counter rolls over to address \$000 allowing the read cycle to be continued indefinitely.

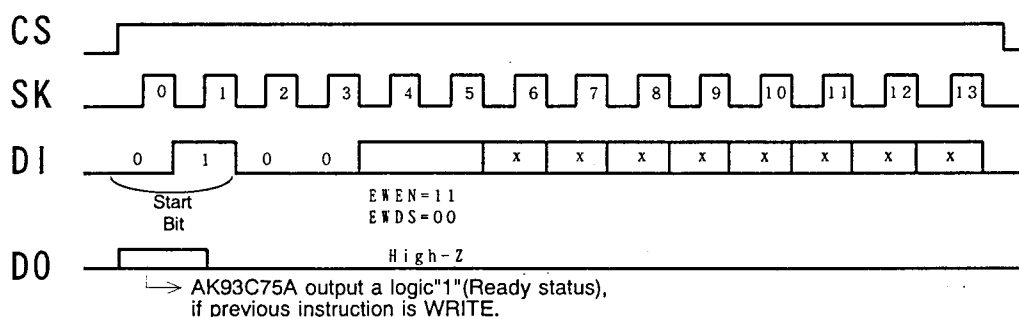


READ

EWEN / EWDS

When Vcc is applied to the part, the part automatically powers up in the ERASE/WRITE Disable state. In the ERASE/WRITE disable state, execution of WRITE instruction is disable. Before WRITE instruction is executed, EWEN instruction must be executed. The ERASE/WRITE enable state continues until EWDS instruction is executed or Vcc is removed from the part.

Execution of a read instruction is independent of both EWEN and EWDS instructions.



EWEN/EWDS

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Power Supply	VCC	- 0.6	+7.0	V
All Input Voltages with Respect to Ground	VIO	- 0.6	VCC+0.6	V
Ambient storage temperature	Tst	- 65	+150	°C

Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum conditions for extended periods may affect device reliability.

Recommended Operating Condition

Parameter	Symbol	Min	Max	Unit
Power Supply	VCC	1.8	5.5	V
Ambient Operating Temperature	Ta	- 40	+85	°C

Electrical Characteristics

(1) D.C. ELECTRICAL CHARACTERISTICS

($1.8\text{V} \leq V_{CC} \leq 5.5\text{V}$, $-40\text{ }^{\circ}\text{C} \leq T_a \leq 85\text{ }^{\circ}\text{C}$, unless otherwise specified)

Parameter	Symbol	Condition	Min.	Max.	Unit
Current Dissipation (WRITE)	ICC1	$V_{CC}=5.5\text{V}$, $t_{SKP}=1\mu\text{s}$, *1		4.0	mA
	ICC2	$V_{CC}=1.8\text{V}$, $t_{SKP}=4\mu\text{s}$, *1		2.0	mA
Current Dissipation (READ,EWE,EWDS)	ICC3	$V_{CC}=5.5\text{V}$, $t_{SKP}=1\mu\text{s}$, *1		0.4	mA
	ICC4	$V_{CC}=1.8\text{V}$, $t_{SKP}=4\mu\text{s}$, *1		0.1	mA
Current Dissipation (Standby)	ICCSB	$V_{CC}=5.5\text{V}$ *2		0.8	μA
Input High Voltage	VIH		$0.8 \times V_{CC}$	$V_{CC} + 0.5$	V
Input Low Voltage	VIL		- 0.1	$0.2 \times V_{CC}$	V
Output High Voltage	VOH1	$2.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ $I_{OH}=-0.1\text{mA}$	$0.8 \times V_{CC}$		V
	VOH2	$1.8\text{V} \leq V_{CC} < 2.5\text{V}$ $I_{OH}=-0.1\text{mA}$	$0.8 \times V_{CC}$		V
Output Low Voltage	VOL1	$2.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ $I_{OL}=1.0\text{mA}$		0.4	V
	VOL2	$1.8\text{V} \leq V_{CC} < 2.5\text{V}$ $I_{OL}=0.1\text{mA}$		0.4	V
Input Leakage	ILI	$V_{CC}=5.5\text{V}$, $V_{IN}=5.5\text{V}$		± 1.0	μA
Output Leakage	ILO	$V_{CC}=5.5\text{V}$ $V_{OUT}=5.5\text{V}$, $CS=GND$		± 1.0	μA

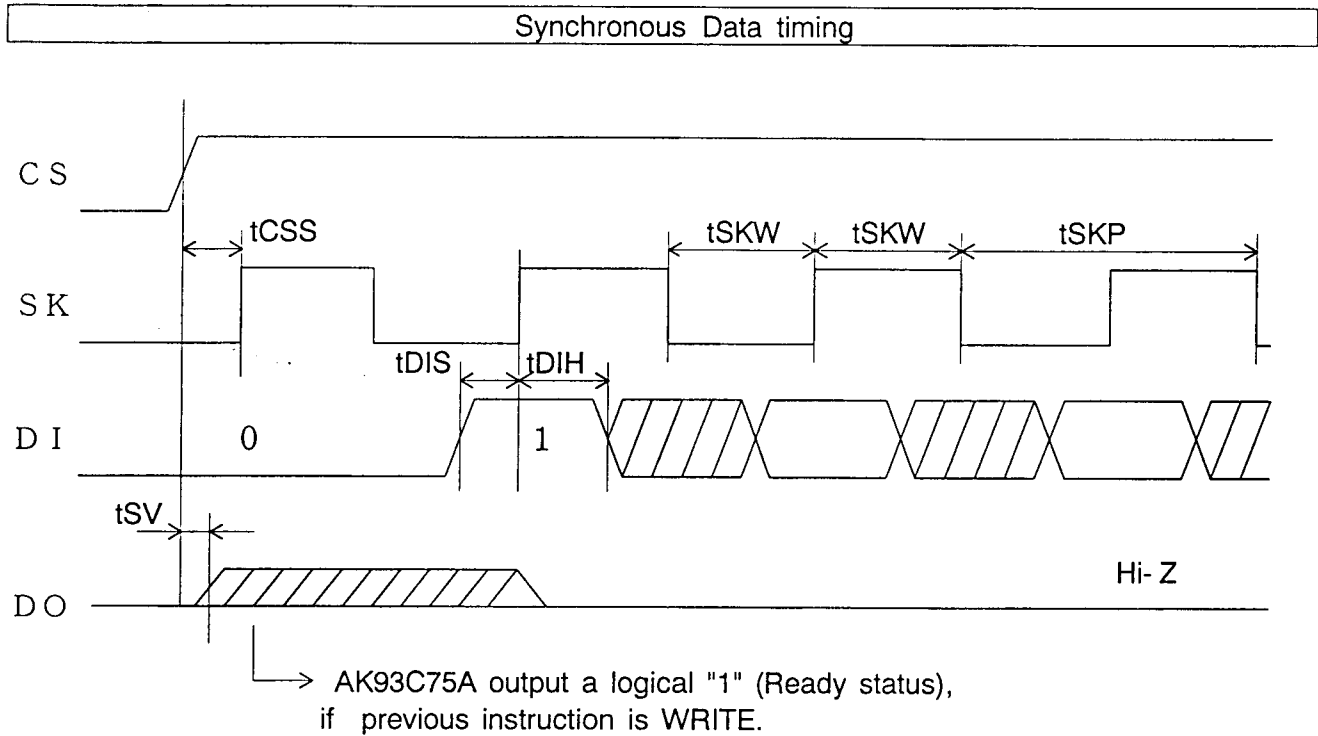
*1 : $V_{IN}=V_{IH}/V_{IL}$, $DO=Open$ *2 : $V_{IN}=V_{CC}/GND$, $CS=GND$, $DO=Open$

(2) A.C. ELECTRICAL CHARACTERISTICS

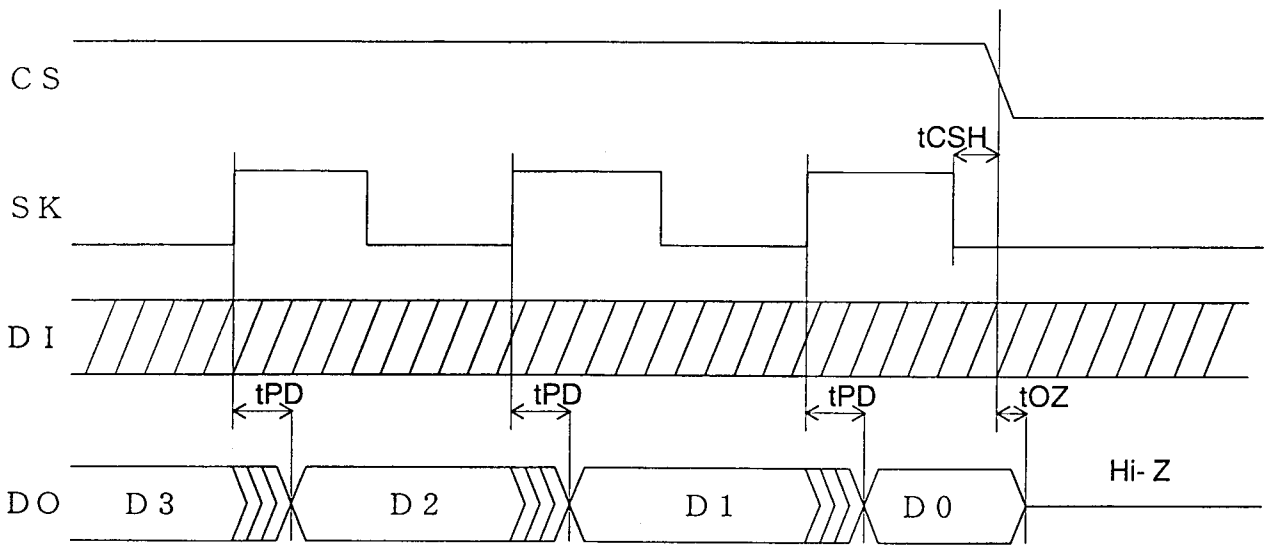
($1.8V \leq V_{CC} \leq 5.5V$, $-40^{\circ}C \leq T_a \leq 85^{\circ}C$, unless otherwise specified)

Parameter	Symbol	Condition	Min.	Max.	Unit
SK Cycle Time	tSKP1	$4.5V \leq V_{CC} \leq 5.5V$	1.0		us
	tSKP2	$2.0V \leq V_{CC} < 4.5V$	2.0		us
	tSKP3	$1.8V \leq V_{CC} < 2.0V$	4.0		us
SK Pulse Width	tSKW1	$4.5V \leq V_{CC} \leq 5.5V$	500		ns
	tSKW2	$2.0V \leq V_{CC} < 4.5V$	1.0		us
	tSKW3	$1.8V \leq V_{CC} < 2.0V$	2.0		us
CS Setup Time	tCSS		100		ns
CS Hold Time	tCSH		0		ns
Data Setup Time	tDIS		200		ns
Data Hold Time	tDIH		200		ns
Output delay	tPD1	$4.5V \leq V_{CC} \leq 5.5V$, *3		500	ns
	tPD2	$2.0V \leq V_{CC} < 4.5V$, *3		1.0	us
	tPD3	$1.8V \leq V_{CC} < 2.0V$, *3		2.0	us
Selftimed Programming Time	tE/W1	$4.5V \leq V_{CC} \leq 5.5V$		8	ms
	tE/W2	$1.8V \leq V_{CC} < 4.5V$		10	ms
Min CS Low Time	tCS		250		ns
CS to Status Valid	tSV	CL=100pF		500	ns
CS to Output High- Z	tOZ1	$2.0V \leq V_{CC} \leq 5.5V$		100	ns
	tOZ2	$1.8V \leq V_{CC} < 2.0V$		250	ns

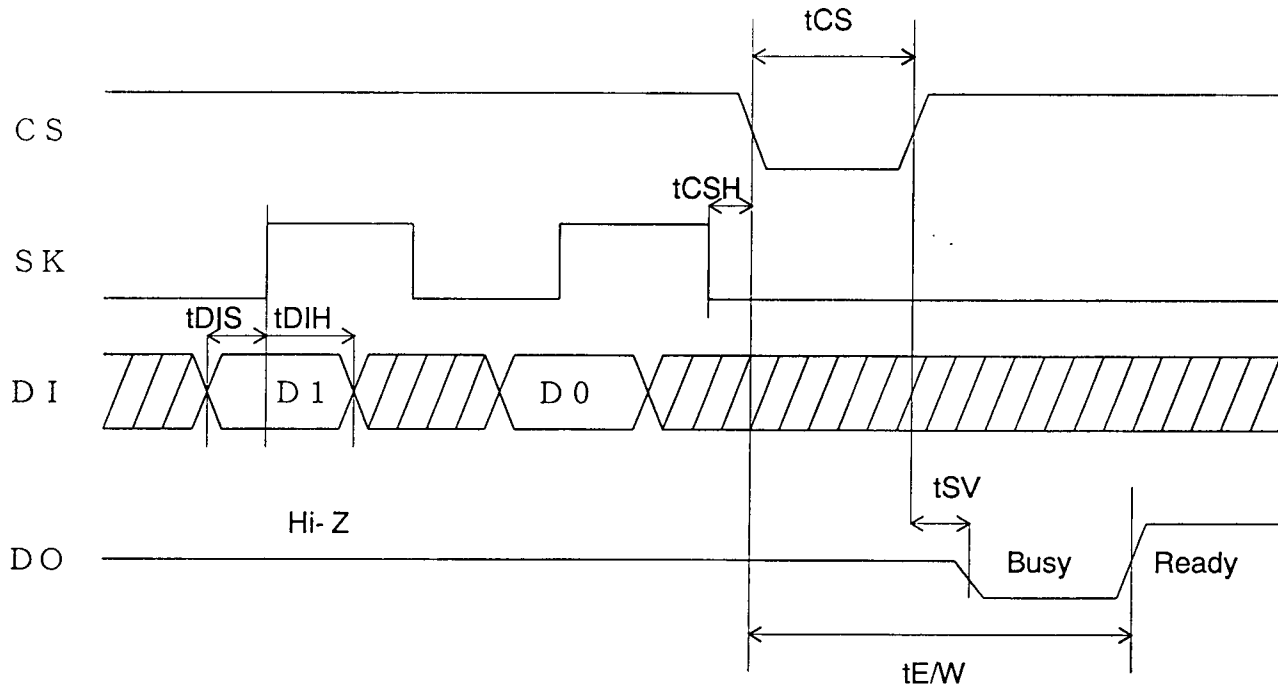
*3 : CL=100pF



The Start of Instruction



The End of Instruction

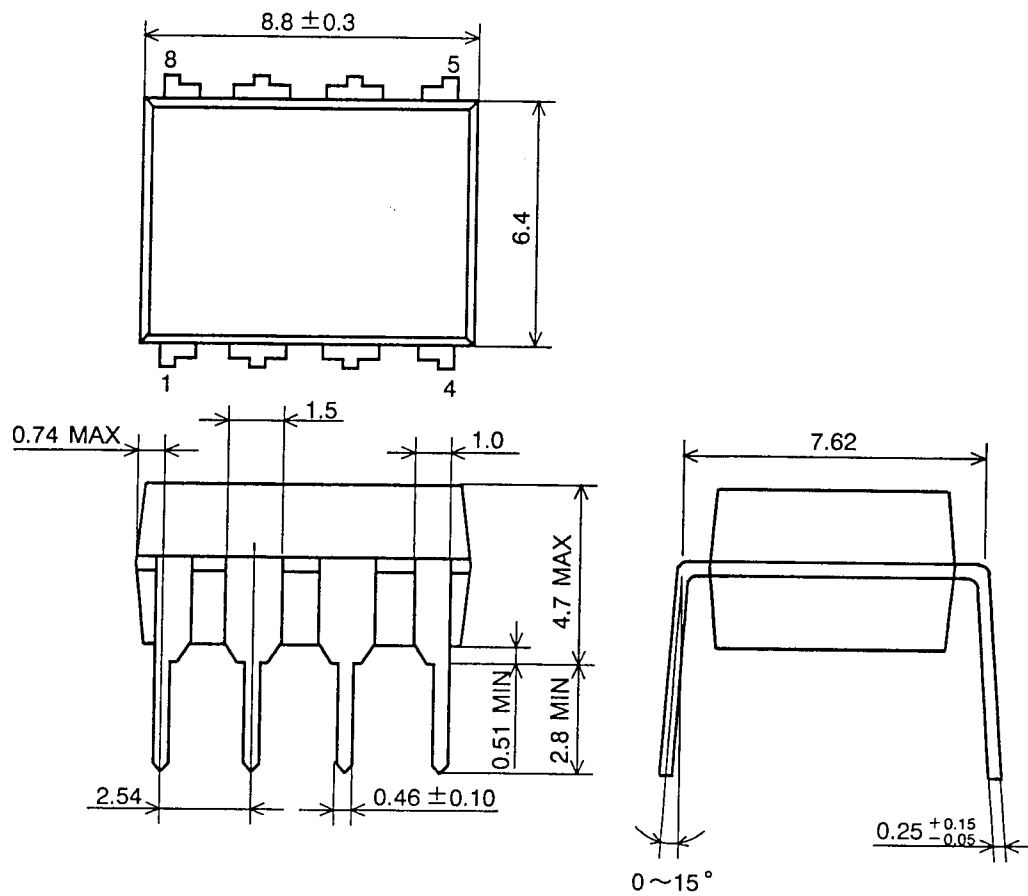


Busy/Ready Signal Output

Package Outline

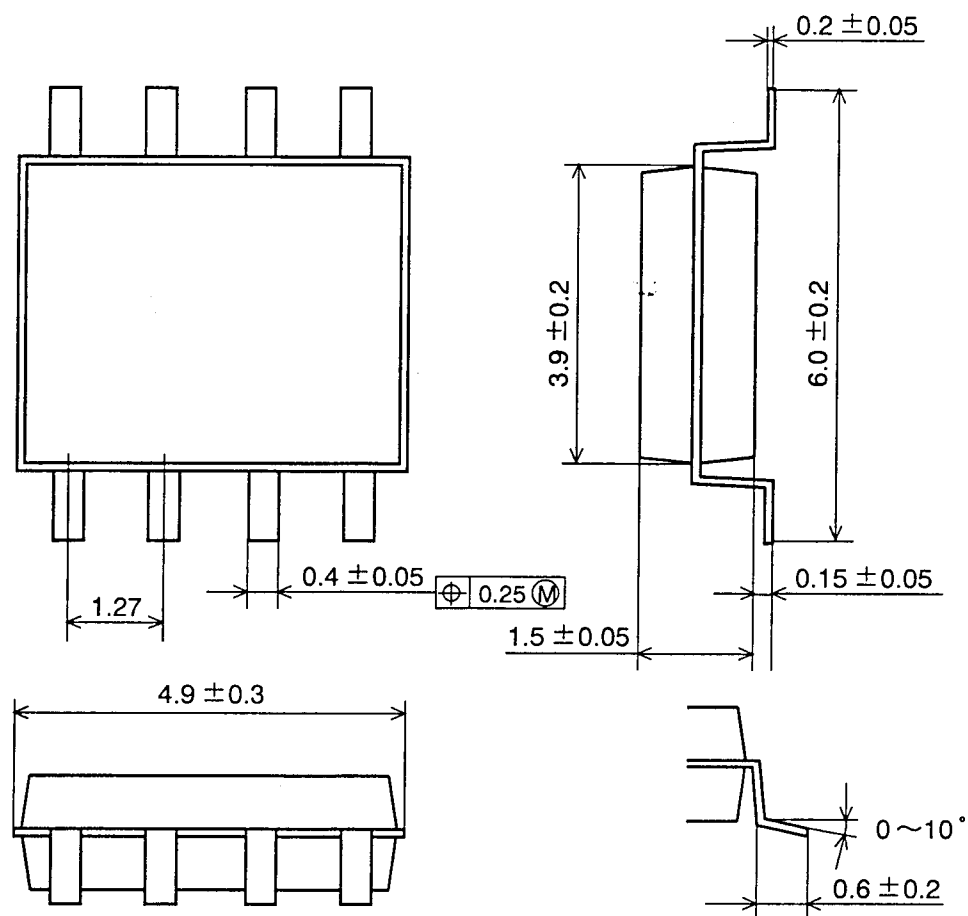
■ 8pin DIP

(Unit : mm)



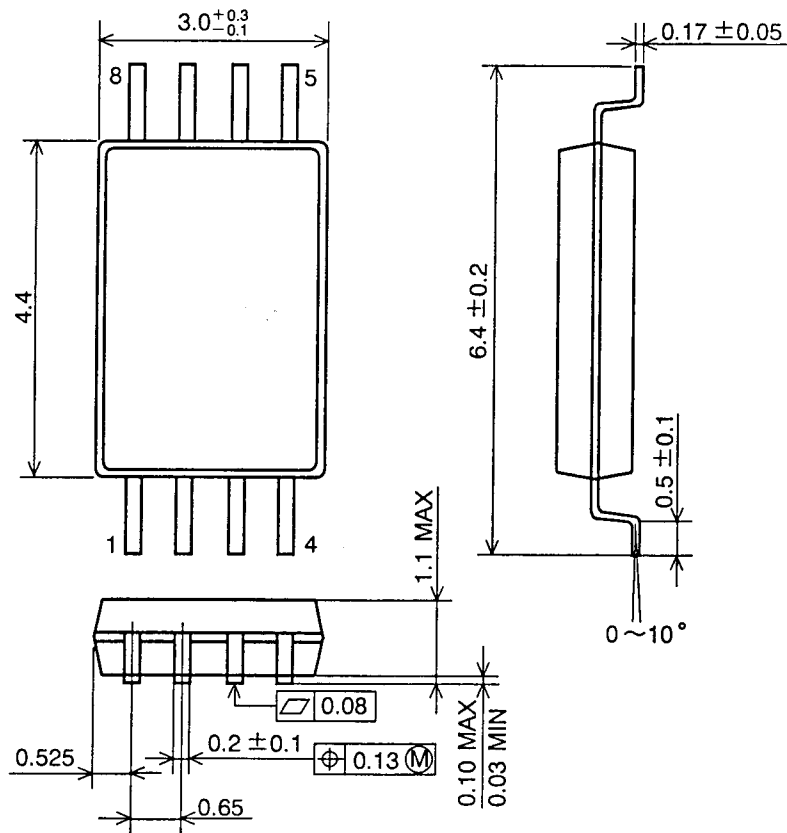
■ 8pin SOP

(Unit : mm)



■ 8pin TSSOP

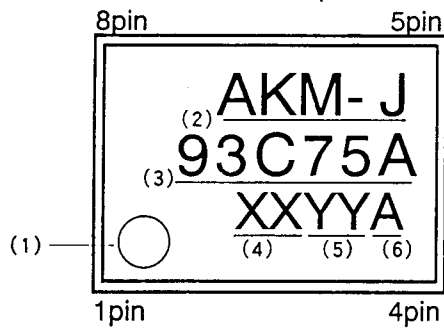
(Unit : mm)



(Notice) These dimension do not include mold flash.

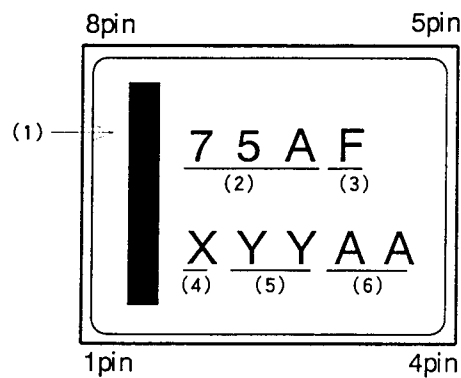
Marking

■ AK93C75A (8pin DIP)



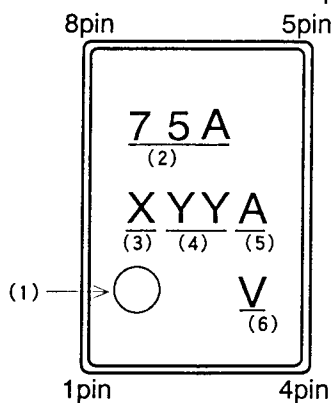
- (1) Pin#1 indication mark
- (2) AKM Mark
- (3) Part#
- (4) Datecode (Year)
- (5) Datecode (Week)
- (6) Lot#

■ AK93C75AF / AK93C75ANF (8pin SOP)



- (1) Pin#1 indication mark
- (2) Part#
- (3) Package type : F = S O P
- (4) Datecode (Year)
- (5) Datecode (Week)
- (6) Lot# (1 or 2 character)

■ AK93C75AV (8pin TSSOP)



- (1) Pin#1 indication mark
- (2) Part#
- (3) Datecode (Year)
- (4) Datecode (Week)
- (5) Lot#
- (6) Package type = : V=TSSOP

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